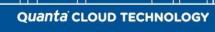




2018/10/15



QCT



Agenda

- Overview
- High Level Features
- Why Needs This Product
- Mechanical View and Dimension
- Key Part Placement
- Design Enhancement
- Design Files Contribution
- OCP Tenets/Principles
- Summary



Overview

Introduction

"QCT Rackgo X OCP AVA-4 M.2 Carrier Card" is storage extension card with Full Height Half length(FHHL) form factor. That supports up to 4x NVMe M.2 form factor SSD. M.2 supported type could be either 110mm (Type 22110) or 80mm (Type 2280) dual sided M.2 modules.

Contributions

- Design package
- Product submission to OCP Marketplace
 - Product Recognition: Accepted level
- Specification Reference
 - Facebook M.2 carrier card v1.0 spec





High Level Features



Product Description	
Product Description	QCT Rackgo X OCP AVA-4 M.2 Carrier Card
Form Factor	
Form Factor	Full Height Half Length (FHHL)
Interface	
Interface	PCIe 3.0 x16 for driving 4x NVMe M.2 SSD
SSD Support Type	
SSD Support Type	Up to 4x 110mm (Type 22110) or 80mm (Type 22080) dual sided M.2 SSD
Environmental Requirements	
Environmental Requirements	 Gaseous contamination: Severity Level G1 per ANSI/ISA 71.04-1985 Ambient operating temperature range: -5°C to +45°C Storage temperature range: -40°C to +70°C (long-term storage) Transportation temperature range: -55°C to +85°C (short-term storage) Operating and storage relative humidity: 10% to 90% (non-condensing) Operating altitude with no de-rating to 2,000m (6,600 feet)



Why Needs This Product

QCT Rackgo X Tioga Pass

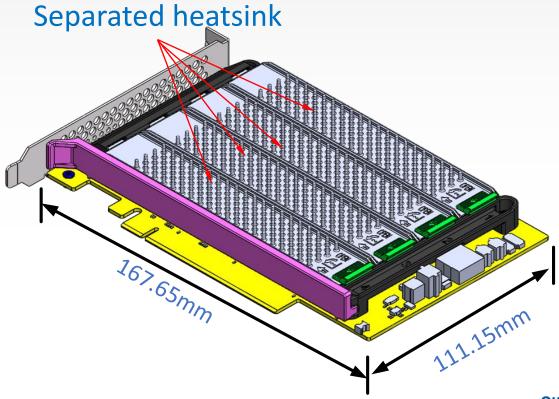


Note: This card only works with compatible system, like QCT Rackgo X Tioga Pass



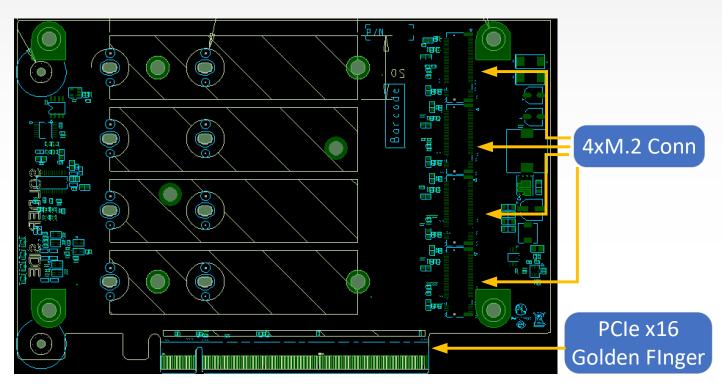
- Difficulty of scale-up upgrade in existing environment. When you are planning to expand your high bandwidth SSD for cache use or storage pool use, but the 2.5" SSD slots are full already
- This product intend to utilize the standard form factor for extra storage demand and enrich the use case of full height PCIe expansion slot for more possibilities over than NIC/GPGPU

Mechanical View and Dimension



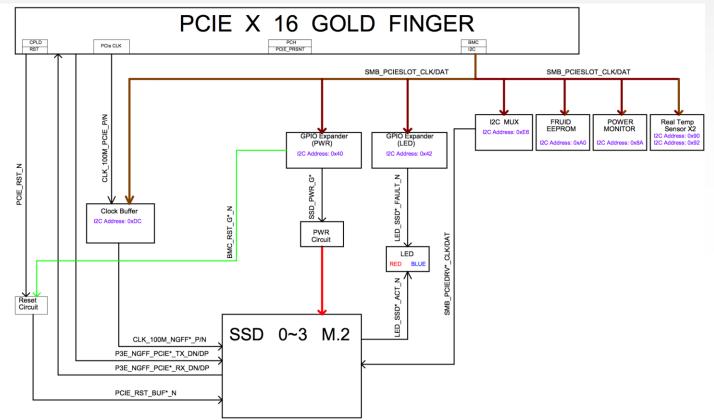


Key Part Placement

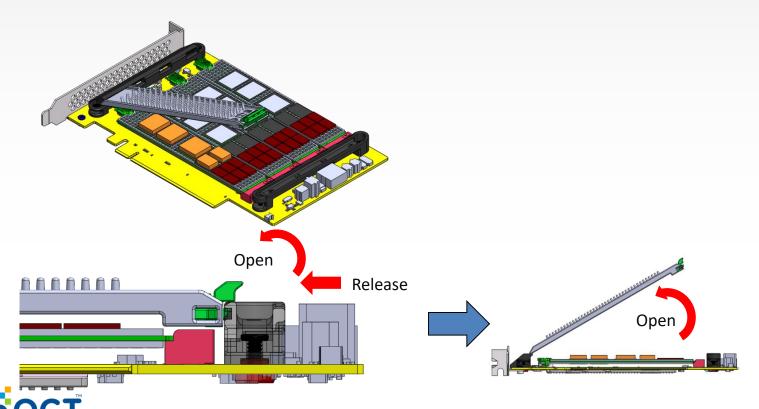




Block Diagram



Easy Changeable Operation of Heatsink & M.2 SSD



Compatible Components List & User Guide

- PCle Bifurcation Requirement:
 - Please be noted that this card only works with the compatible system, like "QCT Rackgo X Tioga Pass".
 - If you plan to adopt or use this card on your own systems directly, please check with your system solution provider to ensure the PClex16 lanes for standard PCle add-in card can be configured or bifurcated to 4x4 for the four M.2 devices which are installed on the AVA-4 M.2 carrier card.
- No supports hot-plug
- PCIe protocol only, no SATA interface support





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Design Enhancement

- Double side heatsink
 - Dissipate the heat from the M.2 module to allow the M.2 carrier card could withstand in harsher environment(up to +45°C)

- Power monitor
 - Real time monitor the main power:12V to take the protective action timely



Design Files Contribution-01_Electricals

➤ 01_Full System Board Layout

DA0F08PC8A0_f08_pcie_ssd_adapter_board_ava_a_brd_071217_ocp_update.zip

02_Full System Schematic CAD

AVA_M2_SSD_ADAPTER_BOARD_20170712.rar



Design Files Contribution-01 Electricals

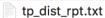
> 03 Full System Component BOM

AVA_PCBA__main_BOM_1214.xlsx

➤ 04 Manufacturing Files



- T2-A12-3LS1UPB0000-A3A-1-C
- T2-A12-4LS1UCS0000-A3A-1-C
- Stackup
 - (Stackup)_S1U_AVA_8L_1p6mm_IT-170GRA1_Rev0p2_20160203.xls
- Test Point Coordinates and Information







Design Files Contribution-02_Mechanicals

Mechanical files

```
■ BOM

AVA BOM.zip

Solidworks

OO – AVA MODULE ASSEMBLY 20171122.zip

STEP

OO – AVA MODULE ASSEMBLY.zip
```



Design Files Contribution-03_Software

> NA, no firmware/software design



OCP Tenets/Principles

Efficiency

➤ Up to scalable 4x M.2 modules with double side heatsink could be used in the environment-friendly data center and cut the TCO(Total Cost of Ownership)

> Scalability

➤ Design with full height dimension which meets PCI SIG CEM standard to be easily adopted for deployment of compute node with storage

Openness

➤ Design with full height dimension which meets PCI SIG CEM standard, with limited design effort on compute node

> Impact

➤ Easily expand the storage pool with existing compute node, reduce the design effort and reserve more space for baseboard design



Thanks!!!

